

CONNECTORS

Operation: 1.0MM PITCH PCI EXPRESS CONNECTORS / [PCI E 连接器]

REACH

RoHS Compliant

LTEM NO.: PCIE-64P11L

(L39.00mm × W8.8mm / 64 CIRCUITS WITH FITTING NAILS)



Technical parameter

PROJECT	LEVEL	A [better product]	
	Contact Rating	0.5A Per PIN / 50V DC	
Electrical Properties	Initial Contact Resistance	50mΩ min.	50mΩ max.
	Insulation Resistance	500MΩ min.	
Durable Performance	Withstand Voltage	300V AC for 1 minute	300 V AC for 1 minut
	There No Load	200 Cycle	
	Rated Load	100 Cycle	
	Storage temp.	-40℃ ~ +85℃ (Operating Temp:)	

表面贴装 SMT

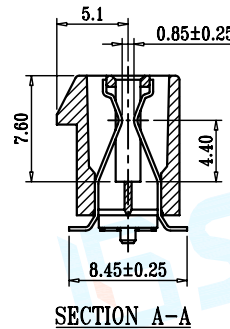
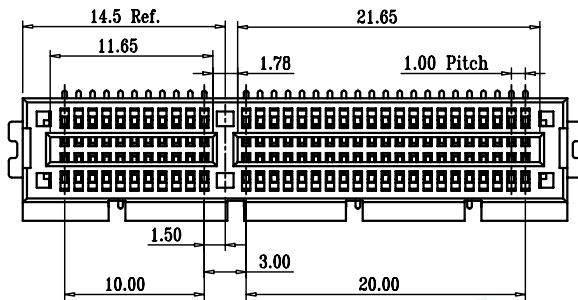
侧向导入 LATERAL

精密部品 NICETY

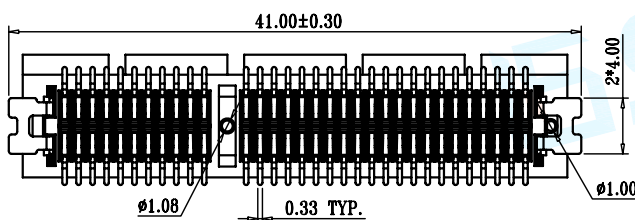
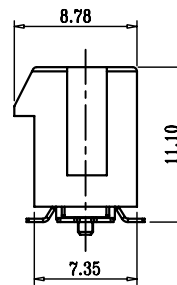
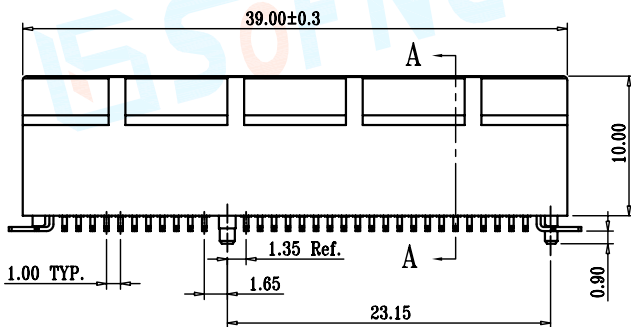
可靠 STABILIZE

適合环保 RoHS

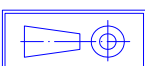
Unit:mm



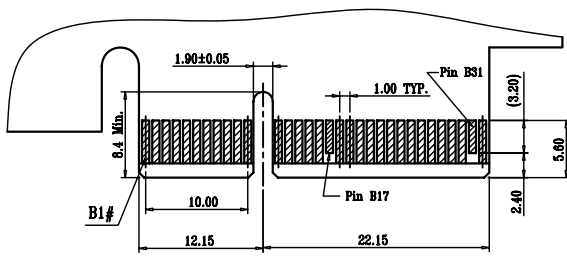
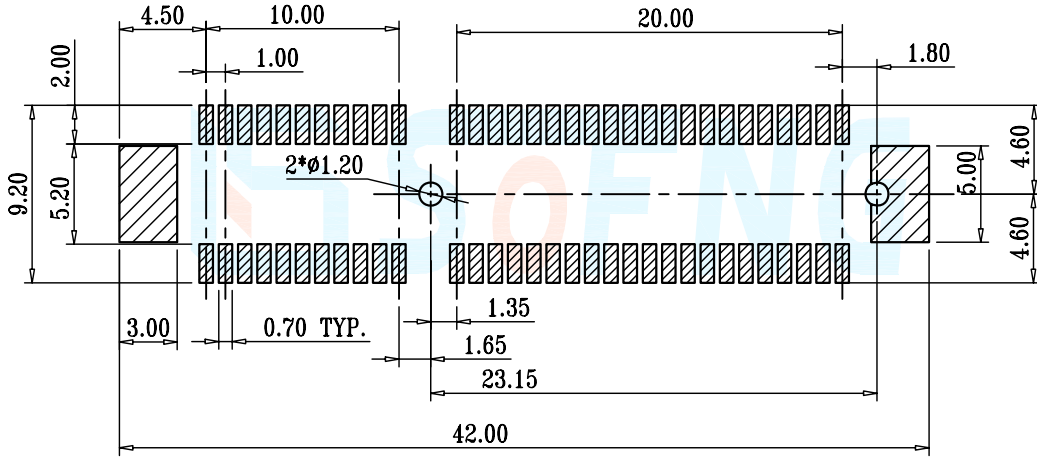
DECIMALS	ANGLES
.X : ±0.25	X.° : ±1.5°
.XX : ±0.15	XX.° : ±1.0°
.XXX : ±0.10	XXX.° : ±0.5°



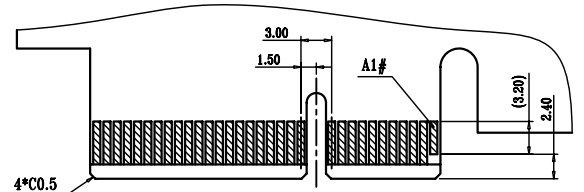
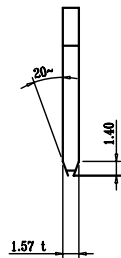
Material declaration			
No.	NAME	MATERIAL	DESCRIPTION
① A	HOUSING 底座	THERMOPLASTIC LCP MG305	UL 94V-0, COLOR: BLACK;
② B	TERMINAL 接触端子	COPPER ALLOY [G/F] 磷铜合金 C5210	2.0 μm Ni PLATED OVERALL; 0.25 μm Au PLATED CONTACT AREA; GOLD FLASH ON SOLDER AREA;
③ C	HOLDDOWN 固定端子	COPPER ALLOY 黄铜 C2680	0.25 μm Ni PLATED OVERALL;



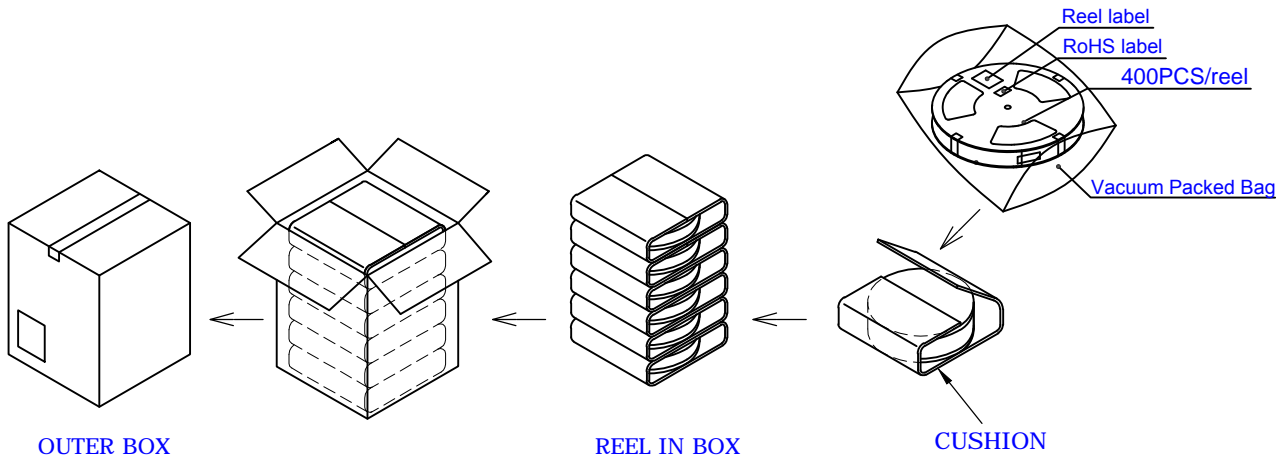
Operating Force	Inward	2.3Kgf MAX.	Solder-ability (Max.)	
	Exiting	2.3Kgf MAX.	IR Reflow: 255°C, 5sec.	Manual: 350°C, 3sec.



RECOMMENDED EDGE CARD PATTERN(PRIMARY SIDE)



RECOMMENDED EDGE CARD PATTERN(SECONDARY SIDE)



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